



## SY88782L

3.3V, 1.25Gbps High-Current, Low-Power  
Laser Driver for Datacom Telecom  
Applications

### General Description

The SY88782L is a single supply 3.3V low power consumption, small-form factor, driver for telecom/datacom applications using FP/DFB lasers at data rates up to 1.25Gbps. The driver can deliver modulation current up to 90mA, and the high compliance voltage it offers makes the part suitable for high-current operation (with the laser AC- or DC-coupled to it.) This device is intended to be used with Micrel MIC3003 Optical Transceiver Management IC which allows for modulation and bias currents control and monitoring, automatic power Control, and temperature compensation.

All support documentation can be found on Micrel's web site at: [www.micrel.com](http://www.micrel.com).

### Features

- 2.3V minimum laser compliance voltage
- 48mA power supply current typical
- Operation up to 1.25Gbps
- Modulation current up to 90mA
- Designed for use with the MIC3003
- Small form factor 3mm x 3mm QFN package

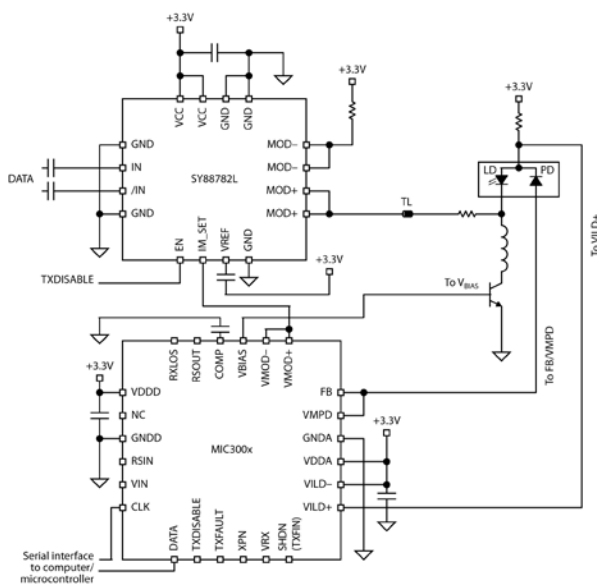
### Applications

- Multi-rate LAN, MAN applications up to 1.25Gbps:
  - Ethernet, SONET OC3/12/24 and SDH STM1/4/8
- SFF, SFP Modules

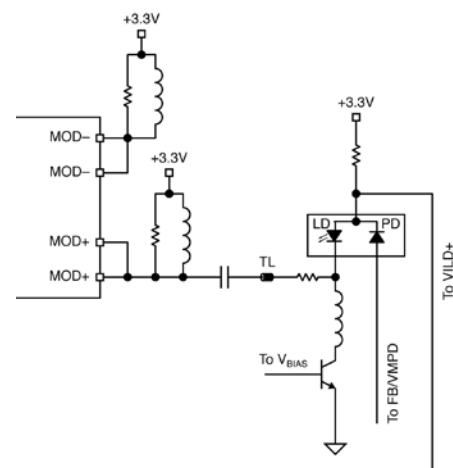
### Markets

- Telecom, Datacom

### Typical Application

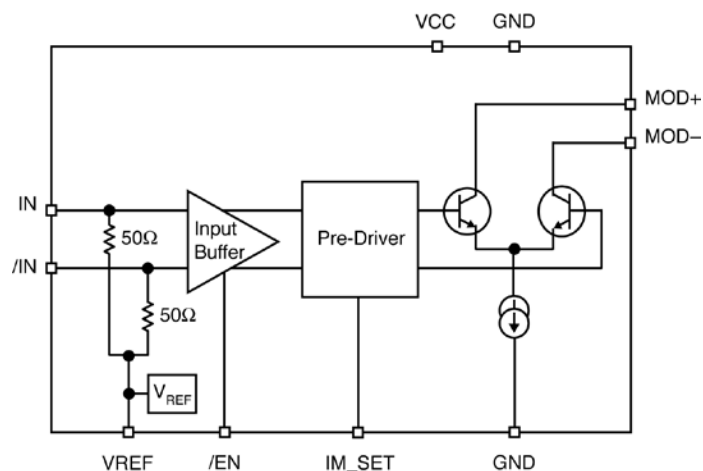


Laser DC-Coupled to the Driver



Laser AC-Coupled to the Driver

## Functional Block Diagram



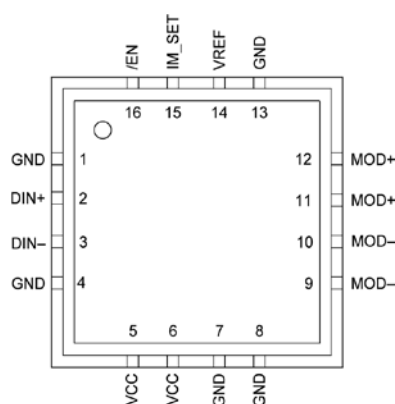
## Ordering Information<sup>(1)</sup>

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY88782LMG	QFN-16	Industrial	782L with Pb-Free bar-line indicator	NiPdAu Pb-Free
SY88782LMGTR <sup>(2)</sup>	QFN-16	Industrial	782L with Pb-Free bar-line indicator	NiPdAu Pb-Free

### Notes:

1. Contact factory for die availability. Dice are guaranteed at  $T_A = +25^\circ\text{C}$ , DC Electricals only.
2. Tape and Reel.

## Pin Configuration



16-Pin QFN

## Pin Description

Pin Name	Pin Number	Pin Function
1, 4, 7, 8, 13	GND	Ground. Ground and exposed pad must be connected to the plane of the most negative potential.
2	DIN+	Non-inverting input data. Internally terminated with $50\Omega$ to a reference voltage.
3	DIN-	Inverting input data. Internally terminated with $50\Omega$ to a reference voltage.
5, 6	VCC	Supply Voltage. Bypass with a $0.1\mu\text{F}/0.01\mu\text{F}$ low-ESR capacitor as close to VCC pin as possible.
9, 10	MOD-	Inverted modulation current output. Outputs modulation current when input data is negative.
11, 12	MOD+	Non-inverted modulation current output. Outputs modulation current when input data is positive.
14	VREF	Reference Voltage. Install a $0.1\mu\text{F}$ capacitor between VREF and VCC.
15	IM_SET	Modulation current setting and control. The voltage applied to this pin will set the modulation current. To be connected to the MIC3003 pin 24 (VMOD+). Input impedance $25\text{K}\Omega$ .
16	/EN	A low-level signal on this pin will enable the output stage of the driver. Internally pulled down with $75\text{K}\Omega$ .

## Truth Table

DIN+	DIN-	/EN	MOD+ <sup>(1)</sup>	MOD-	Laser Output <sup>(2)</sup>
L	H	L	H	L	L
H	L	L	L	H	H
X	X	H	H	L	L

### Notes:

1.  $I_{\text{MOD}} = 0$  when MOD+ = H.
2. Assuming that the laser is tied to MOD+.

**Absolute Maximum Ratings<sup>(1)</sup>**

Supply Voltage ( $V_{IN}$ ) ..... -0.5V to +4.0V  
 CML Input Voltage ( $V_{IN}$ ) .....  $V_{CC}-1.2V$  to  $V_{CC}+0.5V$   
 TTL Control Input Voltage ( $V_{IN}$ ) ..... 0V to  $V_{CC}$   
 Lead Temperature (soldering, 20sec.) ..... +260°C  
 Storage Temperature ( $T_s$ ) ..... -65°C to +150°C

**Operating Ratings<sup>(2)</sup>**

Supply Voltage ( $V_{CC}$ ) ..... +3.0V to +3.6V  
 Ambient Temperature ( $T_A$ ) ..... -40°C to +85°C  
 Package Thermal Resistance<sup>(3)</sup>  
     QFN  
     ( $\theta_{JA}$ ) Still-air ..... 60°C/W  
     ( $\Psi_{JB}$ ) ..... 33°C/W

**DC Electrical Characteristics**

$T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$  and  $V_{CC} = +3.0V$  to  $+3.6V$ , unless otherwise noted. Typical values are  $V_{CC} = +3.3V$ ,  $T_A = 25^\circ\text{C}$ ,  $I_{MOD} = 60\text{mA}$ .

Symbol	Parameter	Condition	Min	Typ	Max	Units
$I_{CC}$	Power Supply Current	Modulation currents excluded		48	65 <sup>(4)</sup>	mA
$V_{MOD\_MIN}$	Minimum Voltage Required at the Driver Output (headroom) for Proper Operation		0.6			V
$R_{IN(DATA)}$	Input Resistance (DIN+, DIN-)		45	50	55	$\Omega$
$V_{ID}$	Differential Input Voltage Swing		200		2400	mV <sub>pp</sub>
/EN Low					0.8	V
/EN High			2			V
$R_{IN(I_{MOD\_SET})}$	$I_{MOD\_SET}$ Input Resistance			25		k $\Omega$
$V_{IM\_SET}$	Voltage Range on $I_{MOD\_SET}$ Pin	$I_{MOD}$ range 10mA to 90mA			1.2	V

**AC Electrical Characteristics**

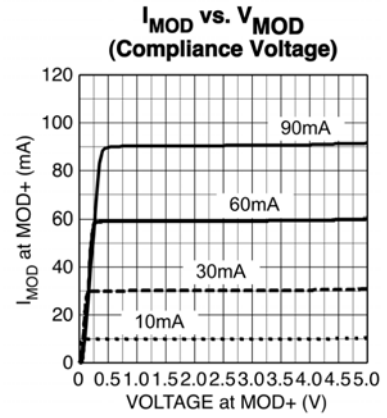
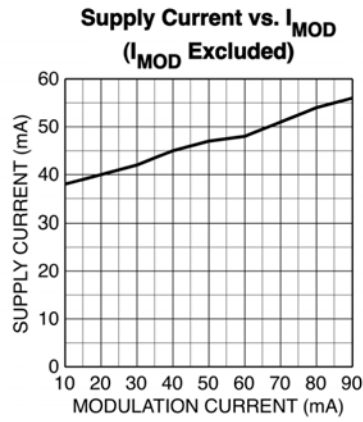
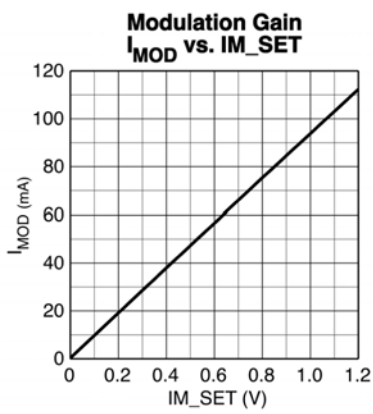
$T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$  and  $V_{CC} = +3.0V$  to  $+3.6V$ , unless otherwise noted. Typical values are  $V_{CC} = +3.3V$ ,  $T_A = 25^\circ\text{C}$ ,  $I_{MOD} = 60\text{mA}$ .

Symbol	Parameter	Condition	Min	Typ	Max	Units
	Data Rate	NRZ	0.05		1.25	Gbps
$I_{MOD}$	Modulation Current <sup>(5)</sup>	AC-coupled	10		90	mA
		DC-coupled	10		70 <sup>(6)</sup>	mA
$I_{MOD\_OFF}$	Modulation OFF Current	Current at MOD+ when the device is disabled			750	$\mu\text{A}$
$t_r$	Output Current Rise Time	20% to 80%, $I_{MOD} = 60\text{mA}$		55	80	ps
$t_f$	Output Current Fall Time	20% to 80%, $I_{MOD} = 60\text{mA}$		55	80	ps
	Total Jitter	@ 1.25Gbps data rate			20	ps <sub>Pp</sub>
	Pulse-Width Distortion				20	ps

**Notes:**

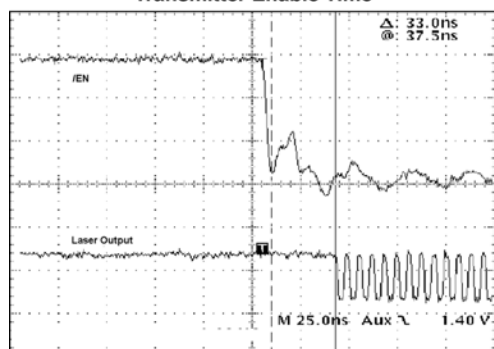
1. Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.
2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
3. Package Thermal Resistance assumes exposed pad is soldered (or equivalent) to the devices most negative potential on the PCB.  $\Psi_{JB}$  uses a 4-layer and  $\theta_{JA}$  in still air unless otherwise stated.
4.  $I_{CC} = 65\text{mA}$  for worst-case conditions with  $I_{MOD} = 90\text{mA}$ ,  $T_A = +85^\circ\text{C}$ ,  $V_{CC} = 3.6V$ .
5. Load = 15 $\Omega$ .
6. Assuming  $V_{CC} = 3.0V$ , Laser bandgap voltage = 1V, laser package inductance = 1nH, laser equivalent series resistor = 5 $\Omega$ , and damping resistor = 10 $\Omega$ .

## Typical Operating Characteristics

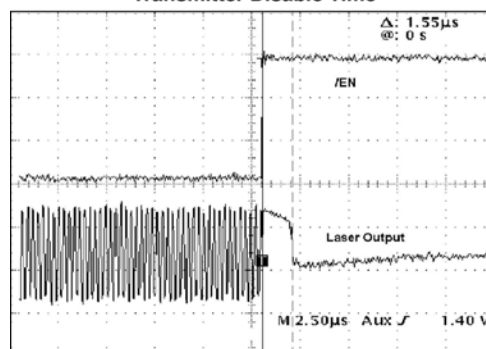


## Functional Characteristics

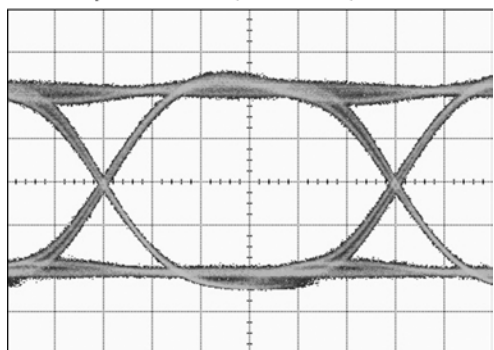
Transmitter Enable Time



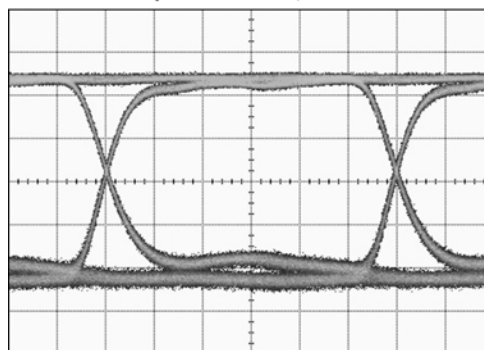
Transmitter Disable Time



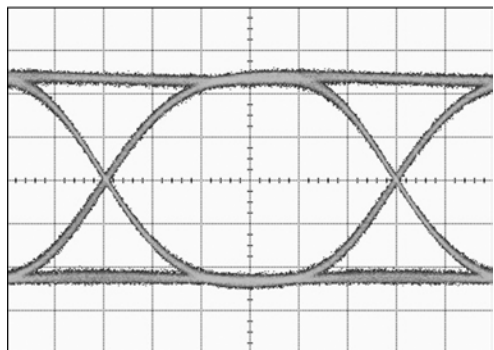
Optical Eye Diagram  
1.25Gbps PRBS  $2^{23}-1$ , ER = 14dB, OC-48 Filter



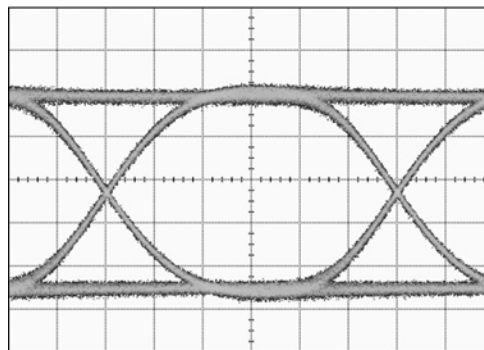
Electrical Eye Diagram  
1.25Gbps PRBS  $2^{23}-1$ , Load = 15Ω



Optical Eye Diagram  
622Mbps PRBS  $2^{23}-1$ , ER = 13dB, OC-12 Filter



Electrical Eye Diagram  
155Mbps PRBS  $2^{23}-1$ , ER = 14dB, OC-3 Filter



## Input and Output Stages

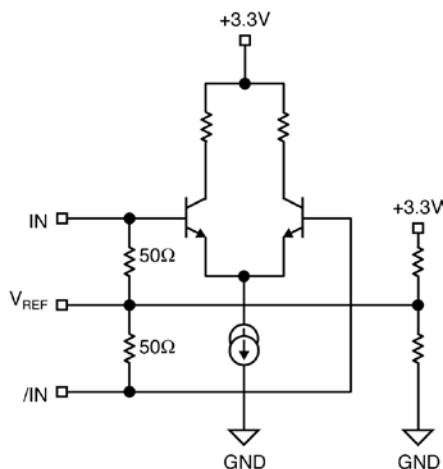


Figure 1a. Simplified Input Stage

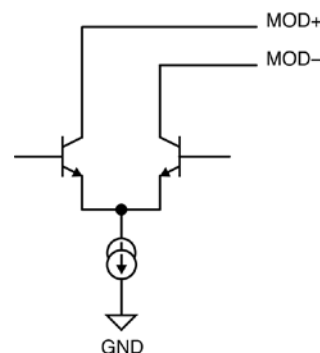


Figure 1b. Simplified Output Stage

## Interface the Input to Different Logic Drivers

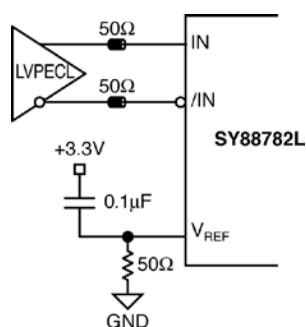


Figure 2a. DC-Coupling to LVPECL Driver

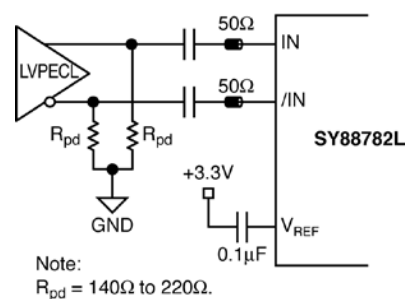


Figure 2b. AC-Coupling to LVPECL Driver

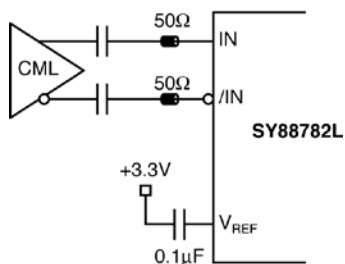


Figure 2c. AC-Coupling to CML Driver

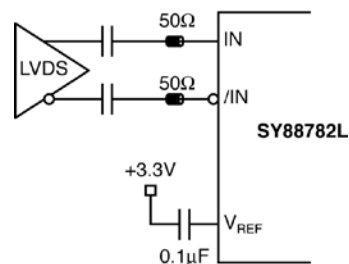
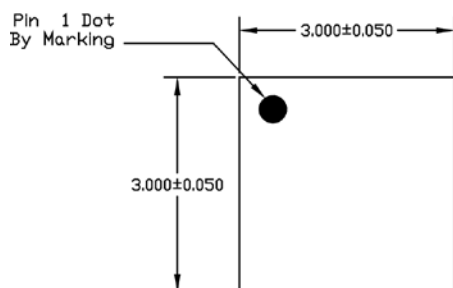
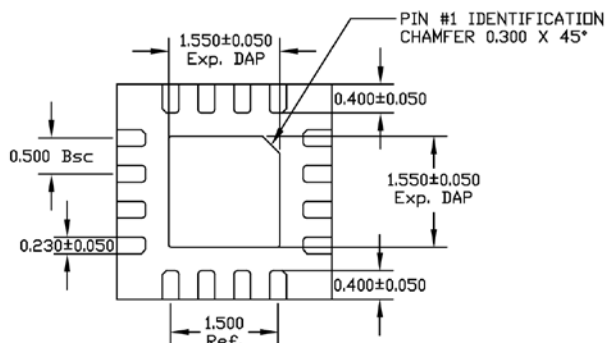
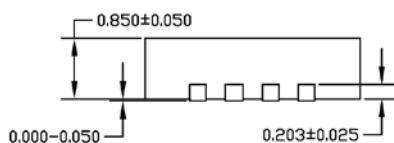


Figure 2d. AC-Coupling to LVDS Driver

**16 LEAD (3mmx3mm)**TOP VIEWBOTTOM VIEWSIDE VIEW

## NOTE:

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. MAX. PACKAGE WARPAGE IS 0.05 mm.
3. MAXIMUM ALLOWABLE BURRS IS 0.076 mm IN ALL DIRECTIONS.
4. PIN #1 ID ON TOP WILL BE LASER/INK MARKED.

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